

The i-EDGE project aims to bring intelligence to devices operating under harsh environments at the edge of the network, by building a next-generation computing platform based on nano-electro-mechanical relays: NEM switches.

Four key objectives are addressed by i-EDGE, supporting the goal of European autonomy in chip manufacturing as per the EU Chips Act:

1. **Advance NEM switches fabrication and integration technology to TRL-5** to achieve 10^{10} hot switching cycles with high yield
2. **Develop System-on-Chip (SoC) hardware solutions using NEM switch integration platform** to co-integrate nanomechanical logic and memory with sensing, wireless trickle charging and data transmission on one chip
3. **Develop CAD tools, firmware and software for NEM-based systems** to facilitate broad usage by application engineers
4. **Map applications identified by Business Interest Group (BIG) to prototype hardware** to facilitate take-up of technology demonstrators in their respective applications

Market studies show that by 2026, automotive MEMS sensors will be a €4.5 billion market, while industrial IoT will be worth €1.2 trillion.

THE i-EDGE PARTNERS REPRESENT A WELL-BALANCED CLUSTER OF INDUSTRIES, SMEs AND ACADEMIC INSTITUTIONS ACROSS SIX DIFFERENT COUNTRIES, AND WORK IN CLOSE COLLABORATION WITH OUR BUSINESS INTEREST GROUP (BIG).



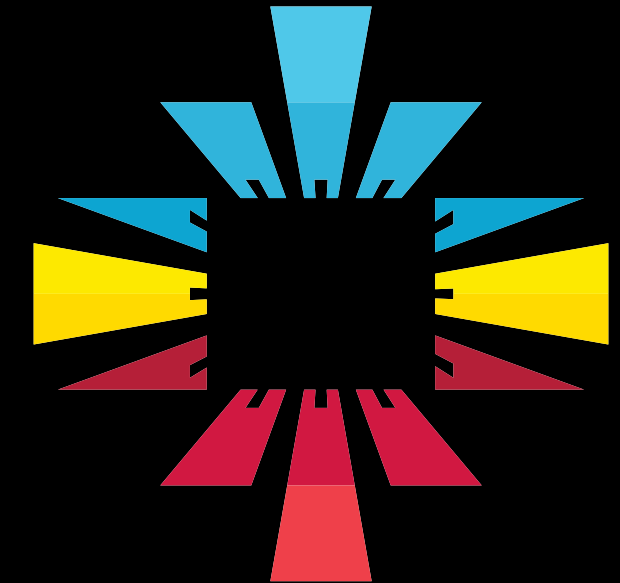
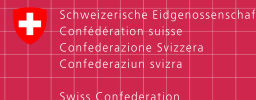
**CONTACT US IF YOU ARE INTERESTED
IN JOINING OUR INDUSTRIAL BOARD**

Project Coordinator
Dr. Jens Bolten
AMO GmbH
info@i-edge-project.eu



This work was supported by the i-EDGE project, which has received funding from the European Union, the Swiss State Secretariat for Education, Research and Innovation (SERI) and UK Research and Innovation (UKRI) under the UK government's Horizon Europe funding guarantee (grant numbers 10061130 and 10063023).

Views and opinions expressed are however those of the author(s) only and do not necessarily reflect those of the European Union, European Health and Digital Executive Agency (HADEA), SERI or UKRI. Neither the European Union nor the granting authorities can be held responsible for them.



EDGE COMPUTING FOR EXTREME ENVIRONMENTS

i-EDGE

www.i-edge-project.eu
[i-edge-project](https://www.linkedin.com/company/i-edge-project)



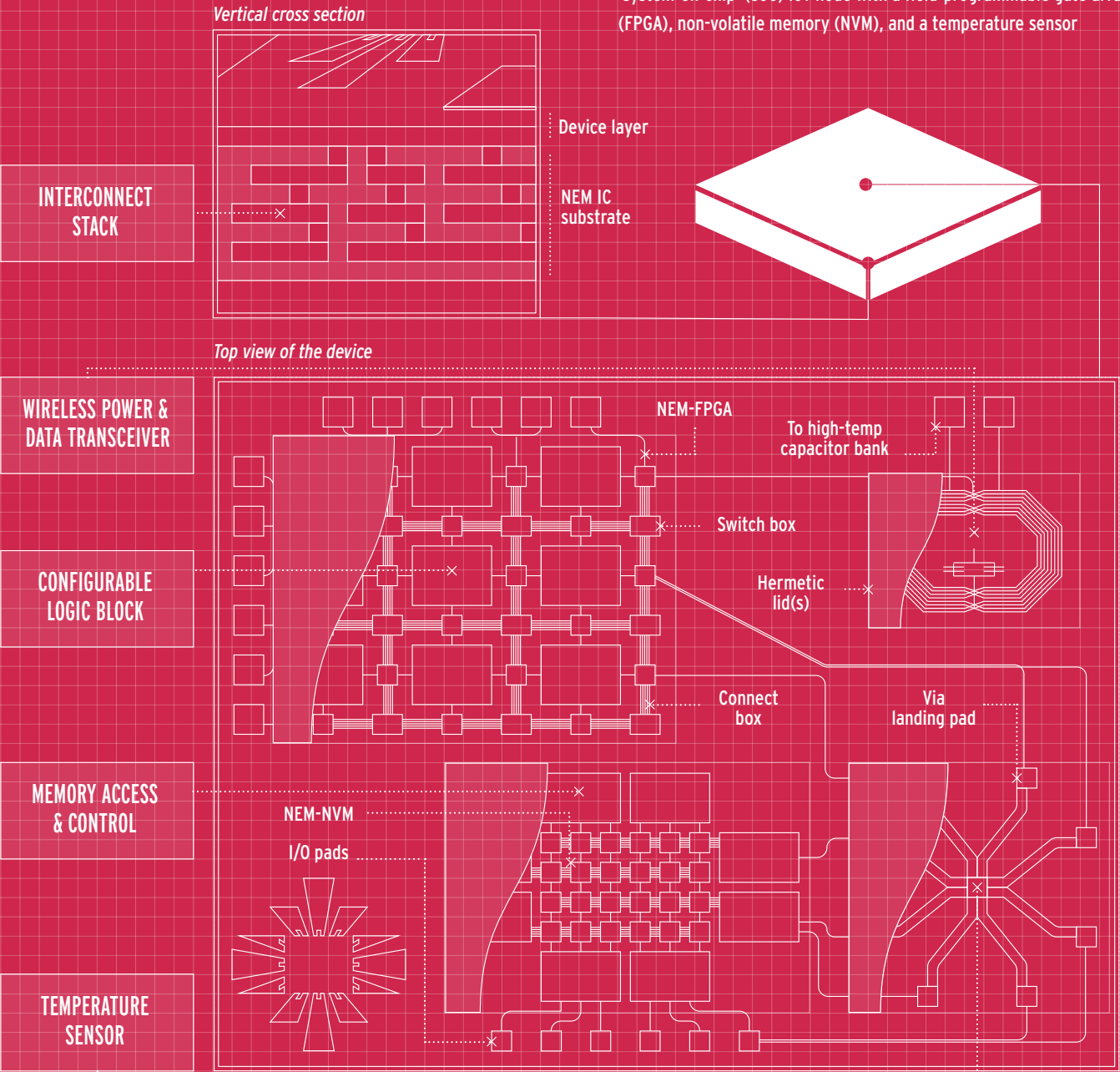
**NEM SWITCHES ARE NANOSCALE RELAYS BASED
ON SEMICONDUCTOR WAFER TECHNOLOGY**

**OUR CHIPS HAVE UNMATCHED CAPABILITY TO OPERATE
AT HIGH TEMPERATURES AND RADIATION WITH ZERO
STANDBY POWER, FOR THE FUTURE IoT**

Project: *i-EDGE*
Duration: 2023-2026
Web: www.i-edge-project.eu

THE i-EDGE DEVICE

Proof-of-concept demonstrator of a NEM switch based 'system-on-chip' (SoC) IoT node with a field-programmable gate array (FPGA), non-volatile memory (NVM), and a temperature sensor



OUR USE CASES

TEMPERATURE RECORDING AND DATALOGGING

To enable easy monitoring of oven temperature profiles, we are replacing CMOS ICs with our NEM switch ICs, and providing a temperature datalogger with no inconvenient trailing wires and boxes

DIGITAL CALIBRATION FOR SENSORS IN HARSH ENVIRONMENTS

To ensure sensor calibration integrity, our high temperature non-volatile memory aims to enable a physical lock of digital calibration data to the sensor whilst reading the memory at up to 325 °C

HIGH RADIATION PROCESSES

To improve human safety and health in the nuclear industry, our i-EDGE platform hopes to allow remote asset tracking and condition monitoring of items such as fuel rods and nuclear waste

ELECTRICAL VEHICLES BATTERY "PASSPORTS"

To simplify battery recycling and passporting, we envisage mounting NEM switch memory to a battery's over current/temperature fuse and locking an event history inside every EV battery

RADIOTHERAPY TREATMENT

To move towards faster mapping of radiation dosage to cancer patients, we wish to explore linking multiple radiation sensors on the patient to our i-EDGE platform for a simple wireless readout